

1.6 x 1.5 x 0.6mm Red & Pure Green Chip LED

OSRP0603C1C

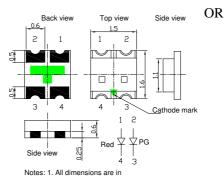
■Features

- Bi-Color
- Super high brightness of surface mount LED
- Water Clear Flat Mold
- Compact package outline
 (LxWxT) of 1.6mm x 1.5mm x 0.6mm
- Compatible to Reflow soldering.

Applications

- Backlighting (switches, keys, etc.)
- Marker lights (e.g. steps, exit ways, etc.)

■Outline Dimension



millimeters;
2. Tolerance is £0.10 mm unless otherwise noted.

Notes: 1. All dimensions are in

Top view

millimeters;
2. Tolerance is ± 0.10 mm unless otherwise noted.

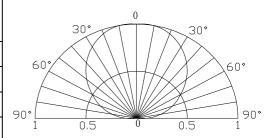
■Absolute Maximum Rating

(Ta=25°C)

Value Symbo Unit Item HR PG DC Forward Current I_{F} 30 30 mA Pulse Forward Current# $I_{FP} \\$ 100 100 mA V Reverse Voltage V_R 5 Power Dissipation mW P_{D} 78 108 $^{\circ}$ C Operating Temperature Topr -40 ~ +85 $^{\circ}$ C Storage Temperature Tstg -40~ +85

Tsol

■Directivity



#Pulse width Max 0.1ms, Duty ratio max 1/10

Lead Soldering Temperature

■Electrical -Optical Characteristics

(Ta=25°C)

260°C/10sec

	Color			$V_{F}(V)$			$I_R(\mu A)$	Iv(mcd)			λD(nm)			2θ1/2(deg)
Part Number				Min.	Тур.	Max.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Тур.
					I _F =5mA		$V_R=5V$				I _F =5mA			
OSRP0603C1C	Red	HR		1.6	2.0	2.4	10	25	50	70	620	625	635	120
	Pure Green	PG		2.6	3.0	3.4	10	80	120	200	515	525	530	120

^{*1} Tolerance of measurements of dominant wavelength is ± 1 nm

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^{*2} Tolerance of measurements of luminous intensity is $\pm 15\%$

^{*3} Tolerance of measurements of forward voltage is±0.1V



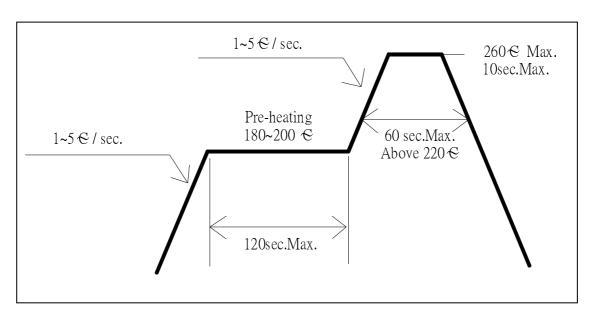
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■ Soldering Conditions

	Reflow Soldering	Har	Hand Soldering				
Pre-Heat	180 ~ 200°C						
Pre-Heat Time	120 sec. Max.						
Peak temperature	260°C Max.	Temperature	350°C Max.				
Dipping Time	10 sec. Max.	Soldering time	3 sec. Max.				
Condition	Refer to Temperature-profile		(one time only)				

• Reflow Soldering Condition(Lead-free Solder)



- *Recommended soldering conditions vary according to the type of LED
- *Although the recommended soldering conditions are specified in the above table, reflow, or hand soldering at the lowest possible temperature is desirable for the LEDs.
- *A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- •All SMD LED products are pb-free soldering available.
- Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

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■ Cautions:

- 1. After open the package, the LED's floor life is 4 Weeks under 30℃ or less and 60%RH or less(MSL:2a).
- 2. Heat generation must be taken into design consideration when using the LED.
- 3. Power must be applied resistors for protection, over current would be caused the optic damage to the devices and wavelength shift.
- 4. Manual tip solder may cause the damage to Chip devices, so advised that heat of iron should be lower than 15W with temperature control under 5 seconds at 230-260 deg. C. (The device would be got damage in re working process, recommended under 5 seconds at 230-260 deg. C)
- 5. All equipment and machinery must be properly grounded. It is recommended to use a wristband or anti-electrostatic glove when handing the LED.
- 6. Use IPA as a solvent for cleaning the LED. The other solvent may dissolve the LED package and the epoxy, Ultrasonic cleaning should not be done.
- 7. Damaged LED will show unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LED get unlight at low current.

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